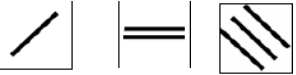

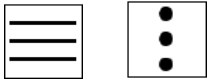







JAE Electronics, Inc.  
February 20<sup>th</sup>, 2018

## ENG-E18-040 – Distributors

### PCN (Process Change Notice) M34S75C4F1 Replacement and Additional Stamp Dies To Keep Product Capacity

Part Number	3 Existing Stamp Dies with 7 Stamp Lines as Marked	1 Replacement Stamp Die with 1 Stamp Line as Marked	Replacement Stamp Die Completion	Proposed PPAP Submission	Start of Mass Production (SOP)
M34S75C4F1	  	 To replace 	April 2018	June 2018	July 2018
		1 Additional Stamp Die with 1 Stamp Line as Marked	Additional Stamp Die Completion	Proposed PPAP Submission	Start of Mass Production (SOP)
			May 2018	July 2018	August 2018

Notes:

- PC = Process Change (in Tooling: Transfer, Replacement, Refurbishment, or additional and Parts Produced at Additional Location, etc...)

- PPAP = Production Part Approval Process

1. PC PPAP will only be prepared and provided to customer who already requested and received Initial PPAP before.
2. If you need PC PPAP documents, please notify us ASAP